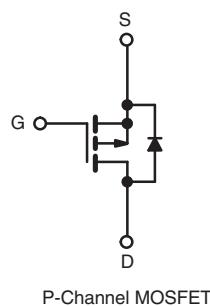
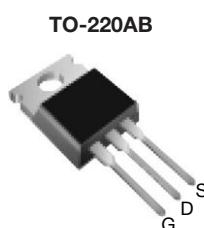


## Power MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V)	- 60	
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = - 10$ V	0.50
$Q_g$ (Max.) (nC)	12	
$Q_{gs}$ (nC)	3.8	
$Q_{gd}$ (nC)	5.1	
Configuration	Single	



### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Ease of Parallelizing
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC


**RoHS\***  
COMPLIANT

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

### ORDERING INFORMATION

Package	TO-220AB
Lead (Pb)-free	IRF9Z14PbF SiHF9Z14-E3
SnPb	IRF9Z14 SiHF9Z14

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	- 60	
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	- 6.7	A
		- 4.7	
Pulsed Drain Current <sup>a</sup>	$I_{DM}$	- 27	
Linear Derating Factor		0.29	W/°C
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	140	mJ
Repetitive Avalanche Current <sup>a</sup>	$I_{AR}$	- 6.7	A
Repetitive Avalanche Energy <sup>a</sup>	$E_{AR}$	4.3	mJ
Maximum Power Dissipation	$P_D$	43	W
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	- 4.5	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature)	for 10 s	300 <sup>d</sup>	
Mounting Torque	6-32 or M3 screw	10	lbf · in
		1.1	N · m

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = - 25$  V, starting  $T_J = 25$  °C,  $L = 3.6$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = - 6.7$  A (see fig. 12).
- $I_{SD} \leq - 6.7$  A,  $dI/dt \leq 90$  A/ $\mu$ s,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.
- 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

**THERMAL RESISTANCE RATINGS**

PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	62	°C/W
Case-to-Sink, Flat, Greased Surface	$R_{thCS}$	0.50	-	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	3.5	

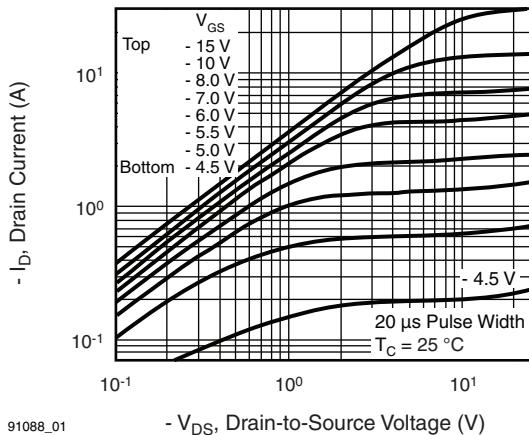
**SPECIFICATIONS** ( $T_J = 25^\circ\text{C}$ , unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
<b>Static</b>								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}$ , $I_D = -250\text{ }\mu\text{A}$		- 60	-	-	V	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25^\circ\text{C}$ , $I_D = -1\text{ mA}$		-	- 0.060	-	$\text{V}/^\circ\text{C}$	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$		- 2.0	-	- 4.0	V	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20\text{ V}$		-	-	$\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -60\text{ V}$ , $V_{GS} = 0\text{ V}$		-	-	- 100	$\mu\text{A}$	
		$V_{DS} = -48\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 150^\circ\text{C}$		-	-	- 500		
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = -10\text{ V}$	$I_D = -4.0\text{ A}^b$	-	-	0.50	$\Omega$	
Forward Transconductance	$g_{fs}$	$V_{DS} = -25\text{ V}$	$I_D = -4.0\text{ A}^b$	1.4	-	-	S	
<b>Dynamic</b>								
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{ V}$ , $V_{DS} = -25\text{ V}$ , $f = 1.0\text{ MHz}$ , see fig. 5		-	270	-	pF	
Output Capacitance	$C_{oss}$			-	170	-		
Reverse Transfer Capacitance	$C_{rss}$			-	31	-		
Total Gate Charge	$Q_g$	$V_{GS} = -10\text{ V}$	$I_D = -6.7\text{ A}$ , $V_{DS} = -48\text{ V}$ , see fig. 6 and 13 <sup>b</sup>	-	-	12	nC	
Gate-Source Charge	$Q_{gs}$			-	-	3.8		
Gate-Drain Charge	$Q_{gd}$			-	-	5.1		
Turn-On Delay Time	$t_{d(on)}$			-	11	-		
Rise Time	$t_r$	$V_{DD} = -30\text{ V}$ , $I_D = -6.7\text{ A}$ , $R_g = 24\text{ }\Omega$ , $R_D = 4.0\text{ }\Omega$ , see fig. 10 <sup>b</sup>		-	63	-	ns	
Turn-Off Delay Time	$t_{d(off)}$			-	10	-		
Fall Time	$t_f$			-	31	-		
Internal Drain Inductance	$L_D$			-	4.5	-	nH	
Internal Source Inductance	$L_S$	Between lead, 6 mm (0.25") from package and center of die contact		-	7.5	-		
<b>Drain-Source Body Diode Characteristics</b>								
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 6.7	A	
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$			-	-	- 27		
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}$ , $I_S = -6.7\text{ A}$ , $V_{GS} = 0\text{ V}^b$		-	-	- 5.5	V	
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ\text{C}$ , $I_F = -6.7\text{ A}$ , $dl/dt = 100\text{ A}/\mu\text{s}^b$		-	80	160	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$			-	0.096	0.19	$\mu\text{C}$	
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )						

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300\text{ }\mu\text{s}$ ; duty cycle  $\leq 2\text{ \%}$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)


91088\_01

-  $I_D$ , Drain Current (A)

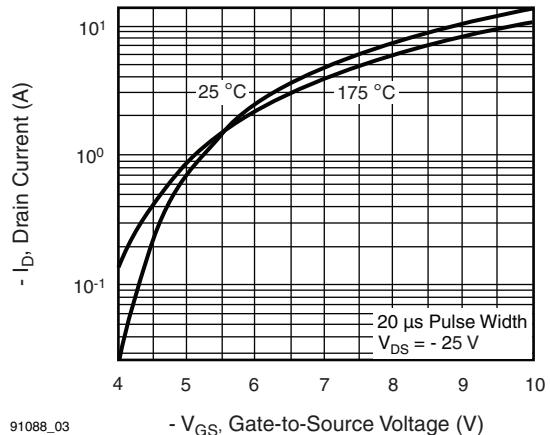
-  $V_{DS}$ , Drain-to-Source Voltage (V)

-  $V_{GS}$

- 15 V  
- 10 V  
- 8.0 V  
- 7.0 V  
- 6.0 V  
- 5.5 V  
- 5.0 V  
- 4.5 V

20  $\mu\text{s}$  Pulse Width

$T_C = 25^\circ\text{C}$



91088\_03

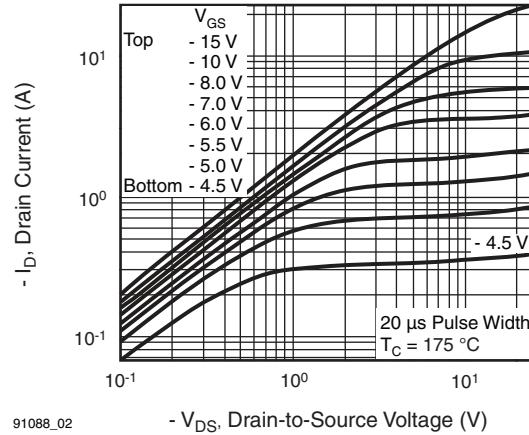
-  $I_D$ , Drain Current (A)

-  $V_{GS}$ , Gate-to-Source Voltage (V)

-  $V_{DS} = -25\text{ V}$

20  $\mu\text{s}$  Pulse Width

25 °C  
175 °C



91088\_02

-  $I_D$ , Drain Current (A)

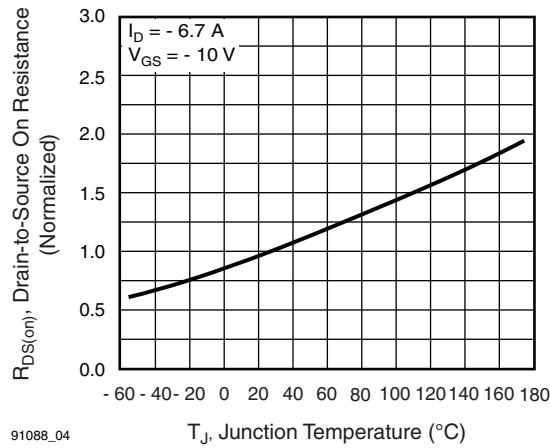
-  $V_{DS}$ , Drain-to-Source Voltage (V)

-  $V_{GS}$

- 15 V  
- 10 V  
- 8.0 V  
- 7.0 V  
- 6.0 V  
- 5.5 V  
- 5.0 V  
- 4.5 V

20  $\mu\text{s}$  Pulse Width

$T_C = 175^\circ\text{C}$



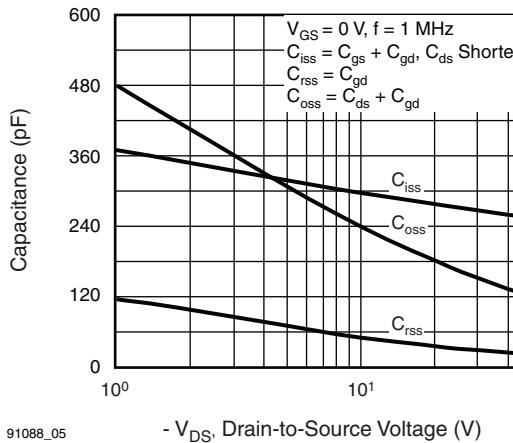
91088\_04

$I_D = -6.7\text{ A}$

$V_{GS} = -10\text{ V}$

$R_{DS(on)}$ , Drain-to-Source On Resistance (Normalized)

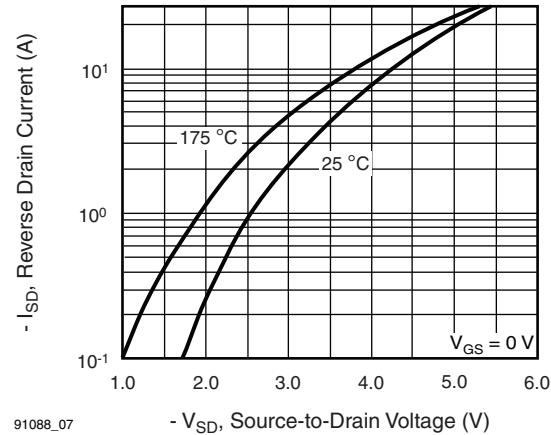
$T_J$ , Junction Temperature ( $^\circ\text{C}$ )



91088\_05

-  $V_{DS}$ , Drain-to-Source Voltage (V)

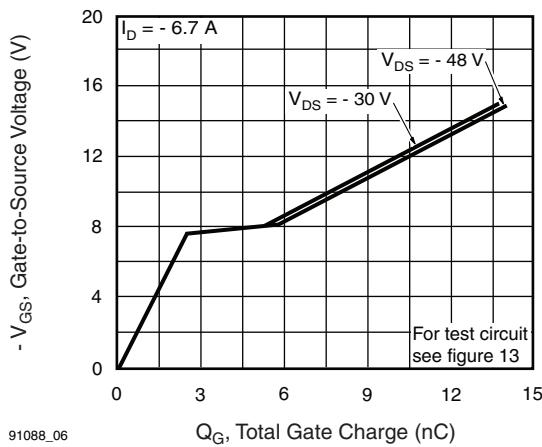
Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



91088\_07

-  $V_{SD}$ , Source-to-Drain Voltage (V)

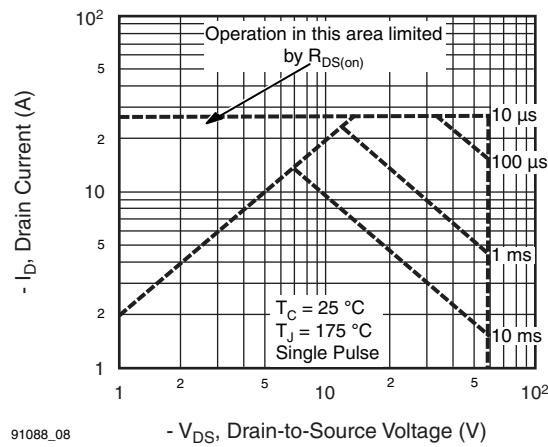
Fig. 7 - Typical Source-Drain Diode Forward Voltage



91088\_06

Q\_G, Total Gate Charge (nC)

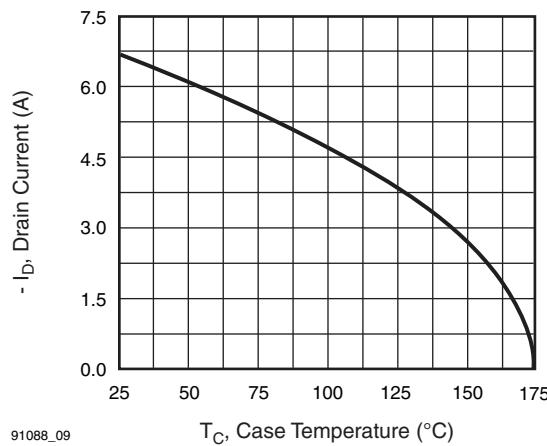
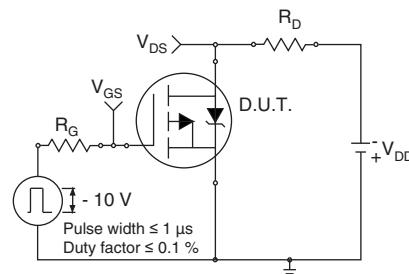
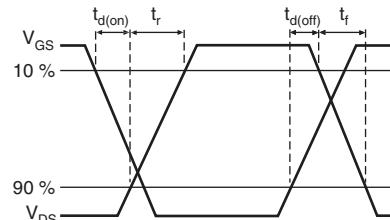
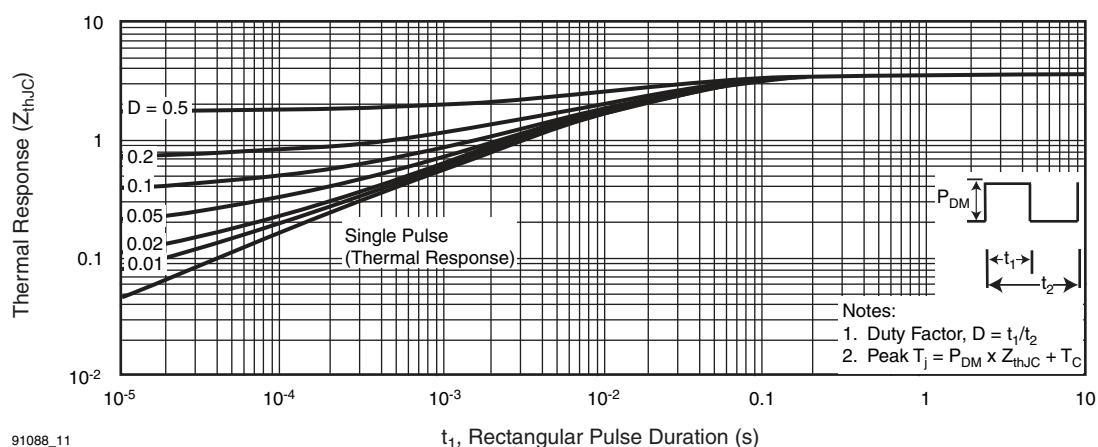
Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



91088\_08

-  $V_{DS}$ , Drain-to-Source Voltage (V)

Fig. 8 - Maximum Safe Operating Area


**Fig. 9 - Maximum Drain Current vs. Case Temperature**

**Fig. 10a - Switching Time Test Circuit**

**Fig. 10b - Switching Time Waveforms**

**Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

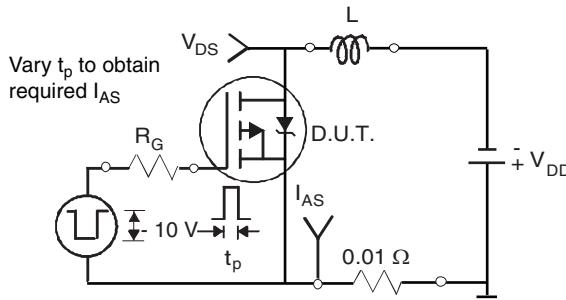


Fig. 12a - Unclamped Inductive Test Circuit

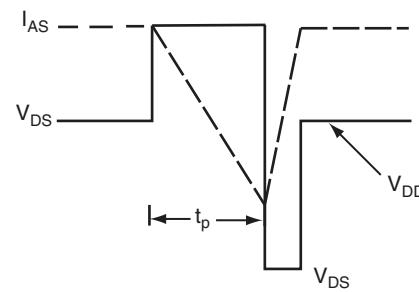


Fig. 12b - Unclamped Inductive Waveforms

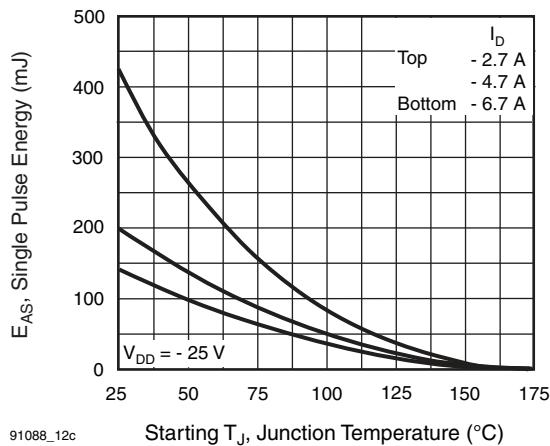


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

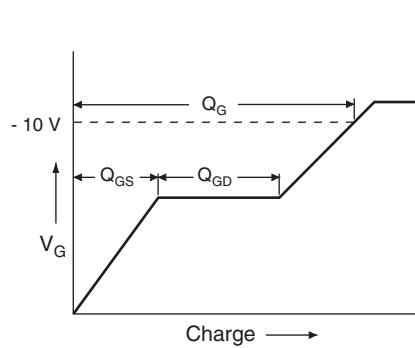


Fig. 13a - Basic Gate Charge Waveform

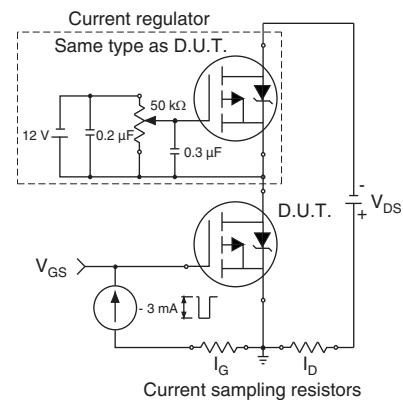
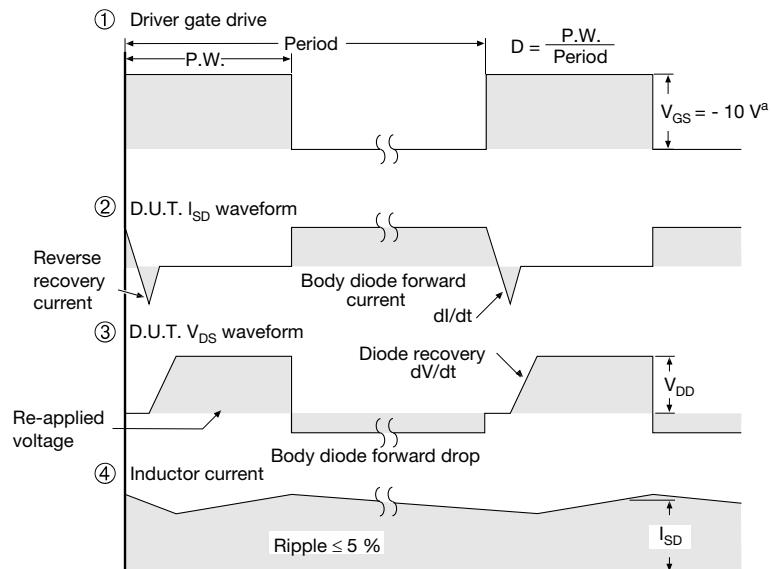
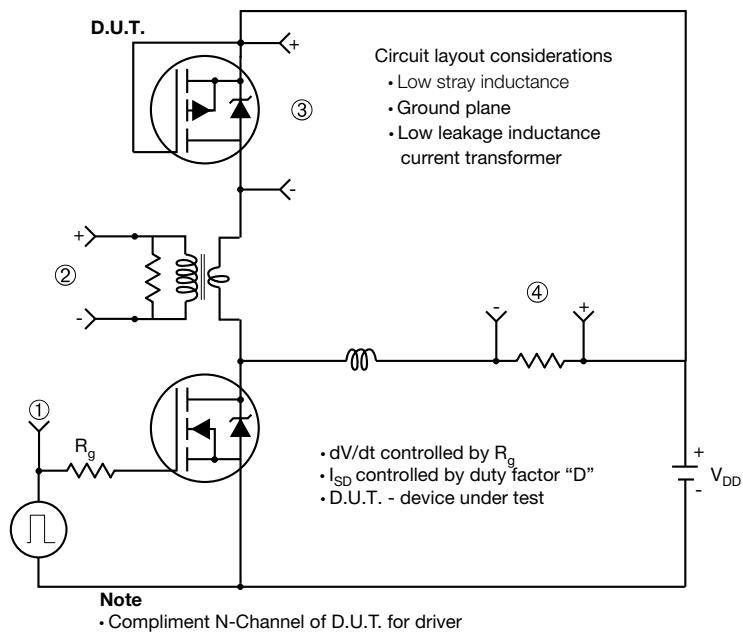


Fig. 13b - Gate Charge Test Circuit

**Peak Diode Recovery dV/dt Test Circuit**

**Fig. 14 - For P-Channel**

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